

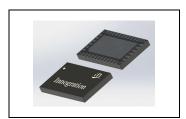
Document Number: GMAH3438-35 Preliminary Datasheet V1.0

3.4-3.8GHz, 35W, 28V GaN PA Module

Description

The GMAH3438-35 is a 35-watt peak power, integrated 2-stage Power Amplifier Module, designed for massive MIMO applications, with frequencies from 3.4 to 3.8GHz.

The module is 50 Ω input fully matched and output partially matched, and requires minimal external components. The module offers a much smaller footprint than traditional discrete component solutions. The module incorporates a symmetrical Doherty final stage and its driver, delivering high power added efficiency for the entire module at 5.6 W average power. Compared to the closest LDMOS MMIC solution, it can support much wider bandwidth up to 400MHz and maintain at least 10% higher efficiency relatively.



Innogration owns the patents for internal Doherty architecture, and related plastic open cavity.

•Typical Performance of Doherty Demo (On Innogration fixture):

 $V_{D1, 2} = 28 \text{ V}, I_{DQ1} = 20 \text{ mA}, I_{DQ3} = 45 \text{ mA}, V_{G2} = -3.5 \text{V}$.

Freq (GHz)	Pulse CW Signal ⁽¹⁾				P _{avg} =37.5dBm WCDMA Signal ⁽²⁾		
	P _{1dB} (dBm)	Gain@ P _{1dB} (dB)	P _{3dB} (W)	η _□ @Ρ ₃ (%)	Gp (dB)	η _D (%)	ACPR _{5M} (dBc)
3.4	44.37	29.24	39.2	67.9	29.3	45	-34
3.6	44.42	30.36	36.7	69.5	30.7	47	-34
3.8	45.11	29.62	36.2	67.8	29.5	45	-31

Notes:

- (1) Pulse Width=20 us, Duty cycle=10%
- (2) WCDMA signal: 3GPP test model 1; 1 to 64 DPCH; Channel Bandwidth=3.84MHz,PAR =10.5 dB at 0.01 % probability on CCDF.

Features

- >400MHz RF bandwidth, flexible to support any sub-band like 3.4-3.6/3.5-3.7/3.6-3.8GHz etc
- · High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- 50 Ω Input fully matched
- Integrated Doherty Final Stage
- 6x10 mm Surface Mount Open plastic Package
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

Pin Configuration and Description





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Pin No.	Symbol	Description		
6	RF IN	RF Input		
1	VDS-driver	Driver stage, Drain Bias		
4	VGS-driver	Driver stage, Gate Bias		
19,21	RF Out2	RF Output, Main Amplifier		
22,24	RF Out1	RF Output, Peaking Amplifier		
11	VGS-main	Main Amplifier, Gate Bias		
16,17	VDS-main	Main Amplifier, Drain Bias		
32	VGS-peak	Peaking Amplifier, Gate Bias		
26,27	VDS-Peak	Peaking Amplifier, Drain Bias		
3,8-10,14,15,28,29,33-35	NC	No connection		
2,5,7,12,13,18,20,23,25,30,31,36	GND	Internal Grounding, recommend connecting to Epad ground		
		DC/RF Ground. Must be soldered to EVB ground plane over array of		
Package Base	GND	vias for thermal and RF performance. Solder voids under Pkg Base will		
		result in excessive junction temperatures causing permanent damage.		

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	100	Vdc
GateSource Voltage	V_{GS}	-10 to +1	Vdc
Operating Voltage	V _{DD}	+40	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	Tc	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance@Average Power, Junction to Case			
Tcase=+85℃, Tch=126.5℃, CW Test, Pdiss=9W,	Rejc	4.6	°C/W
Pout=5W,			

Notes:

- (1) The thermal resistance is acquired by our company's FEA model, which was calibrated by IR measurement, the value shall be applied to reliability.
- (2) The reference Tcase temperature 85℃ is apply on the backside of package.
- (3) The device soldering onto the 20mil Rogers PCB with 50×Φ0.4mm via hole beneath the package backside and the reference temperature Tcase (85°C) apply on the groundside of the PCB.
- (4) The power dissipation in the table is overall dissipation which include Carrier PA, Peaking PA and driver PA.

Table 3. ESD Protection Characteristics

Test Methodology	Class Voltage	
Human Body Model(HBM) (JEDEC Standard JESD-A114)	±225V	
Charged Device Model (CDM) (JEDEC Standard JESD22-C101F)	±1000V	

Load Mismatch of per Section (On Test Fixture, 50 ohm system): $V_{D1.2} = 28 \text{ V}$, $I_{DQ1} = 20 \text{ mA}$, $I_{DQ3} = 45 \text{mA}$, $V_{G2} = -3.5 \text{V}$, f = 3.6 GHz

VSWR 10:1 at P3dB pulse CW Output Power	No Device Degradation
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TYPICAL CHARACTERISTICS

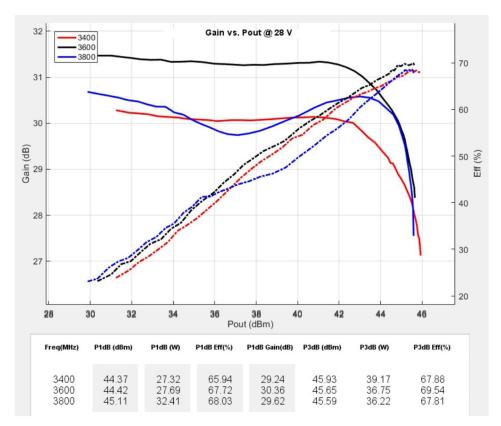


Figure 1. Power Gain and Drain Efficiency as Function of Pulse Output Power

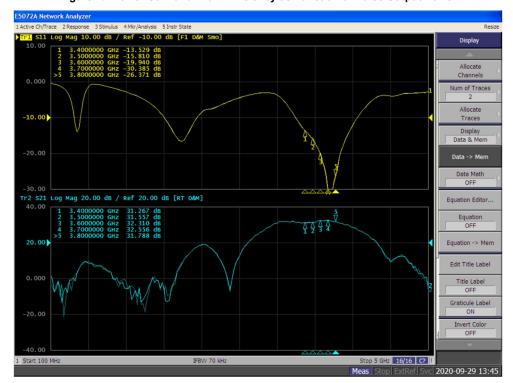
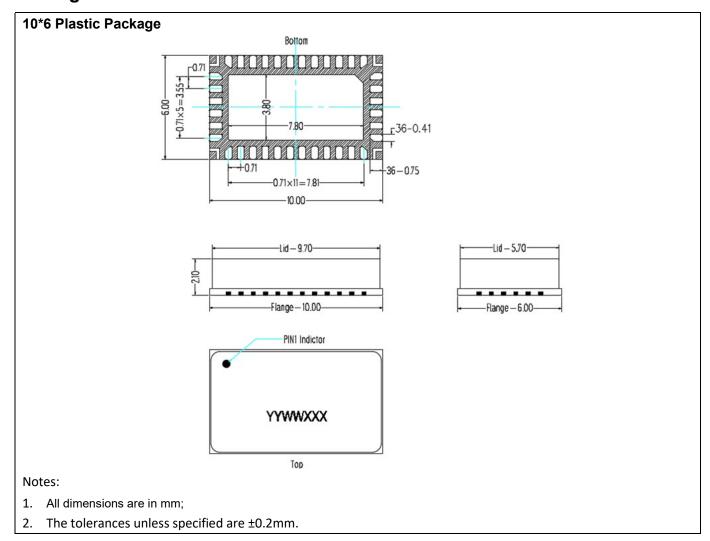


Figure 3. Network analyzer output S11/S21

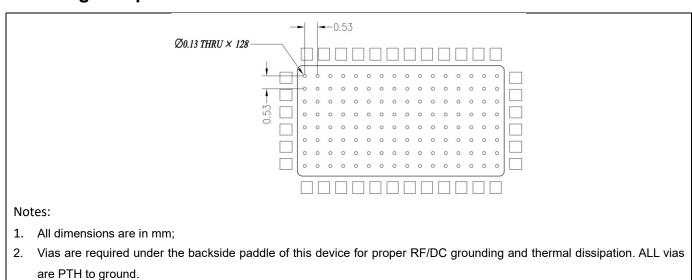
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Package Dimensions



Mounting Footprint Pattern





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Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status
2020/9/29	Rev 1.0	Preliminary Datasheet

Application data based on LWH-20-32

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